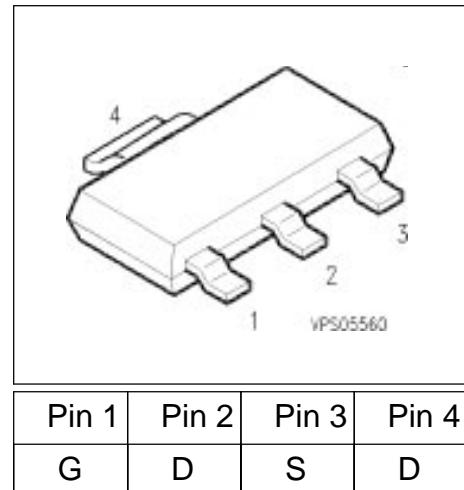


SIPMOS® Small-Signal Transistor

- N channel
- Enhancement mode
- Logic Level
- Avalanche rated
- $V_{GS(th)} = 1.2 \dots 2.0 \text{ V}$



| Type | V_{DS} | I_D | $R_{DS(on)}$ | Package | Marking |
|---------|----------|-------|---------------|---------|---------|
| BSP 318 | 60 V | 2.6 A | 0.15 Ω | SOT-223 | BSP 318 |

| Type | Ordering Code | Tape and Reel Information |
|---------|---------------|---------------------------|
| BSP 318 | Q67000-S127 | E6327 |

Maximum Ratings

| Parameter | Symbol | Values | Unit |
|--|-------------|----------|------|
| Continuous drain current $T_A = 25 \text{ }^\circ\text{C}$ | I_D | 2.6 | A |
| DC drain current, pulsed $T_A = 25 \text{ }^\circ\text{C}$ | I_{Dpuls} | 10.4 | |
| Avalanche energy, single pulse $I_D = 2.6 \text{ A}, V_{DD} = 25 \text{ V}, R_{GS} = 25 \Omega$ $L = 1.38 \text{ mH}, T_j = 25 \text{ }^\circ\text{C}$ | E_{AS} | 8 | mJ |
| Gate source voltage | V_{GS} | ± 14 | |
| Gate-source peak voltage, aperiodic | V_{gs} | ± 20 | V |
| Power dissipation $T_A = 25 \text{ }^\circ\text{C}$ | P_{tot} | 1.8 | |

Maximum Ratings

| Parameter | Symbol | Values | Unit |
|--|------------|---------------|------|
| Chip or operating temperature | T_j | -55 ... + 150 | °C |
| Storage temperature | T_{stg} | -55 ... + 150 | |
| Thermal resistance, chip to ambient air | R_{thJA} | ≤ 70 | K/W |
| Thermal resistance, junction-soldering point ¹⁾ | R_{thJS} | ≤ 10 | |
| DIN humidity category, DIN 40 040 | | E | |
| IEC climatic category, DIN IEC 68-1 | | 55 / 150 / 56 | |

1) Transistor on epoxy pcb 40 mm x 40 mm x 1,5 mm with 6 cm² copper area for drain connection

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

| Parameter | Symbol | Values | | | Unit |
|-----------|--------|--------|------|------|------|
| | | min. | typ. | max. | |

Static Characteristics

| | | | | | |
|--|---------------|-----|------|------|---------------|
| Drain- source breakdown voltage $V_{GS} = 0 \text{ V}$, $I_D = 0.25 \text{ mA}$, $T_j = 25^\circ\text{C}$ | $V_{(BR)DSS}$ | 60 | - | - | V |
| Gate threshold voltage $V_{GS} = V_{DS}$, $I_D = 1 \text{ mA}$ | $V_{GS(th)}$ | 1.2 | 1.6 | 2 | |
| Zero gate voltage drain current $V_{DS} = 60 \text{ V}$, $V_{GS} = 0 \text{ V}$, $T_j = 25^\circ\text{C}$ | I_{DSS} | - | 0.1 | 1 | μA |
| | | - | 10 | 100 | |
| $V_{DS} = 60 \text{ V}$, $V_{GS} = 0 \text{ V}$, $T_j = 125^\circ\text{C}$ | | | | | |
| Gate-source leakage current $V_{GS} = 20 \text{ V}$, $V_{DS} = 0 \text{ V}$ | I_{GSS} | - | 10 | 100 | nA |
| Drain-Source on-state resistance $V_{GS} = 5 \text{ V}$, $I_D = 2.6 \text{ A}$ | $R_{DS(on)}$ | - | 0.12 | 0.15 | Ω |

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

| Parameter | Symbol | Values | | | Unit |
|-----------|--------|--------|------|------|------|
| | | min. | typ. | max. | |

Dynamic Characteristics

| | | | | | |
|---|--------------|-----|-----|-----|----|
| Transconductance $V_{DS} \geq 2 * I_D * R_{DS(on)max}$, $I_D = 2.6 \text{ A}$ | g_{fs} | 2.4 | 5.6 | - | S |
| Input capacitance $V_{GS} = 0 \text{ V}$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$ | C_{iss} | - | 580 | 770 | pF |
| Output capacitance $V_{GS} = 0 \text{ V}$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$ | C_{oss} | - | 180 | 270 | |
| Reverse transfer capacitance $V_{GS} = 0 \text{ V}$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$ | C_{rss} | - | 70 | 105 | |
| Turn-on delay time $V_{DD} = 30 \text{ V}$, $V_{GS} = 5 \text{ V}$, $I_D = 0.3 \text{ A}$ $R_{GS} = 50 \Omega$ | $t_{d(on)}$ | - | 12 | 20 | ns |
| Rise time $V_{DD} = 30 \text{ V}$, $V_{GS} = 5 \text{ V}$, $I_D = 0.3 \text{ A}$ $R_{GS} = 50 \Omega$ | t_r | - | 30 | 45 | |
| Turn-off delay time $V_{DD} = 30 \text{ V}$, $V_{GS} = 5 \text{ V}$, $I_D = 0.3 \text{ A}$ $R_{GS} = 50 \Omega$ | $t_{d(off)}$ | - | 90 | 120 | |
| Fall time $V_{DD} = 30 \text{ V}$, $V_{GS} = 5 \text{ V}$, $I_D = 0.3 \text{ A}$ $R_{GS} = 50 \Omega$ | t_f | - | 70 | 95 | |

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

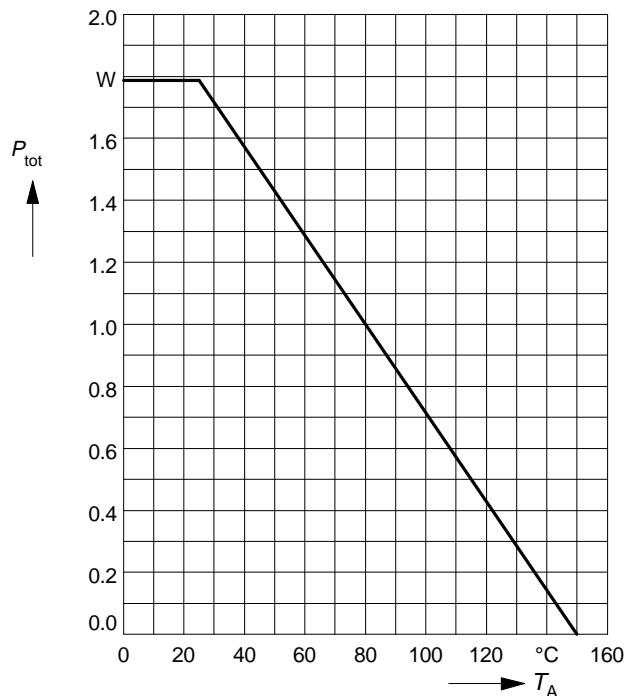
| Parameter | Symbol | Values | | | Unit |
|-----------|--------|--------|------|------|------|
| | | min. | typ. | max. | |

Reverse Diode

| | | | | | |
|--|----------|---|------|------|---------------|
| Inverse diode continuous forward current $T_A = 25^\circ\text{C}$ | I_S | - | - | 2.6 | A |
| Inverse diode direct current,pulsed $T_A = 25^\circ\text{C}$ | I_{SM} | - | - | 10.4 | |
| Inverse diode forward voltage $V_{GS} = 0 \text{ V}, I_F = 5.2 \text{ A}, T_j = 25^\circ\text{C}$ | V_{SD} | - | 0.95 | 1.2 | V |
| Reverse recovery time $V_R = 30 \text{ V}, I_F=I_S, dI_F/dt = 100 \text{ A}/\mu\text{s}$ | t_{rr} | - | 40 | - | ns |
| Reverse recovery charge $V_R = 30 \text{ V}, I_F=I_S, dI_F/dt = 100 \text{ A}/\mu\text{s}$ | Q_{rr} | - | 0.04 | - | μC |

Power dissipation

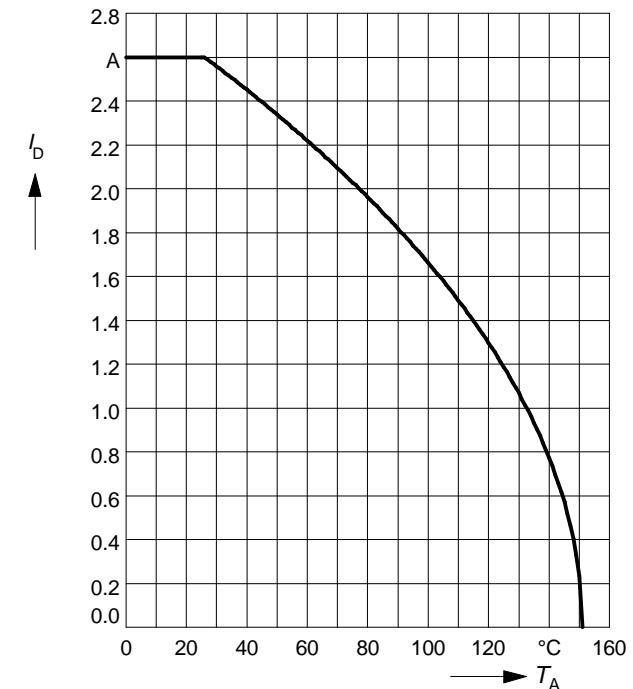
$$P_{\text{tot}} = f(T_A)$$



Drain current

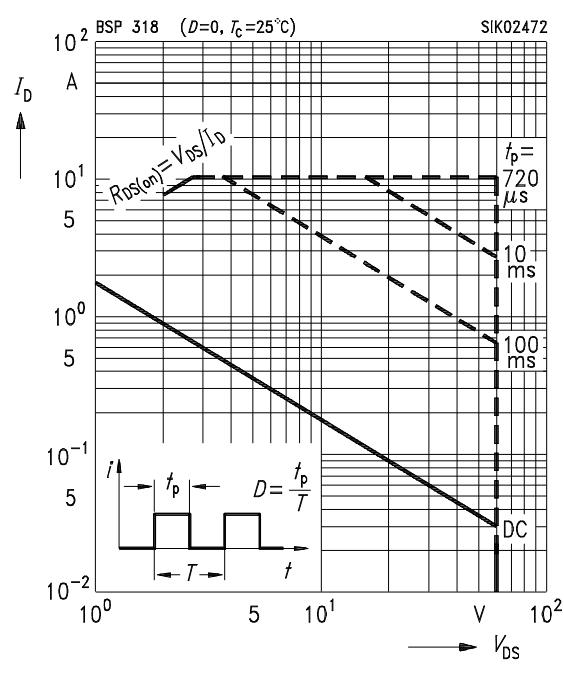
$$I_D = f(T_A)$$

parameter: $V_{GS} \geq 5$ V



Safe operating area $I_D=f(V_{DS})$

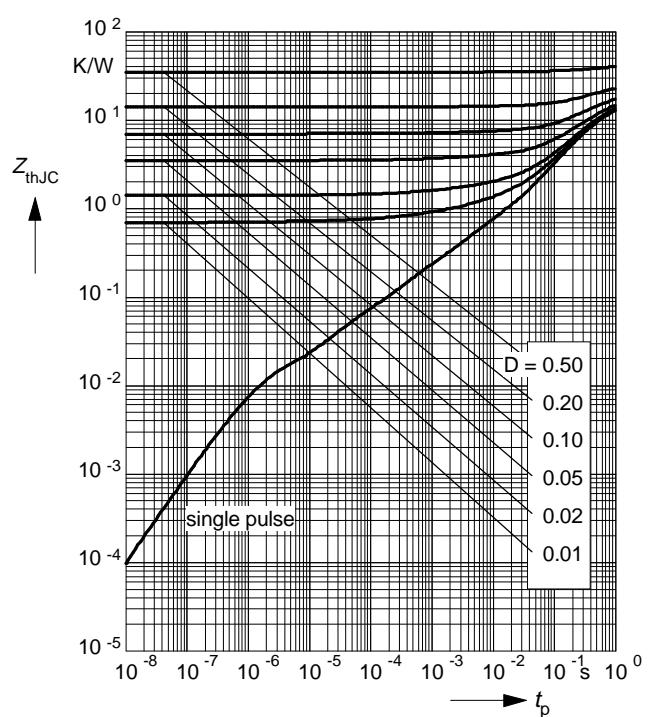
parameter : $D = 0$, $T_C=25^\circ\text{C}$



Transient thermal impedance

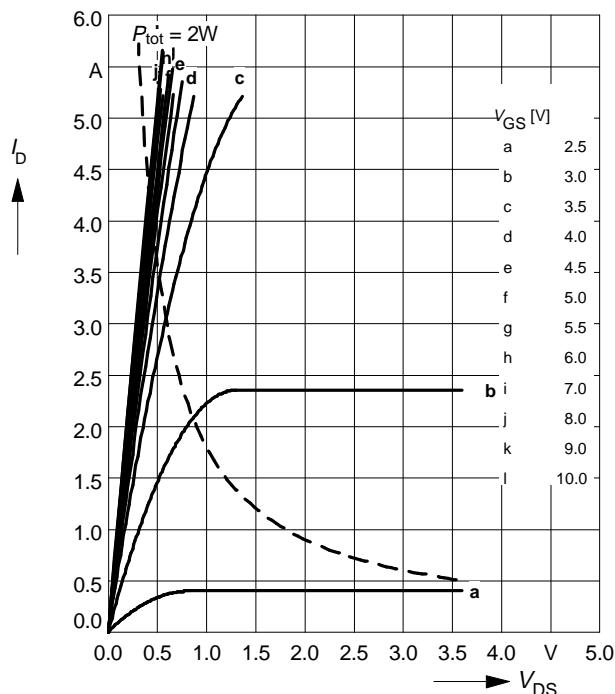
$$Z_{\text{th JA}} = f(t_p)$$

parameter: $D = t_p / T$

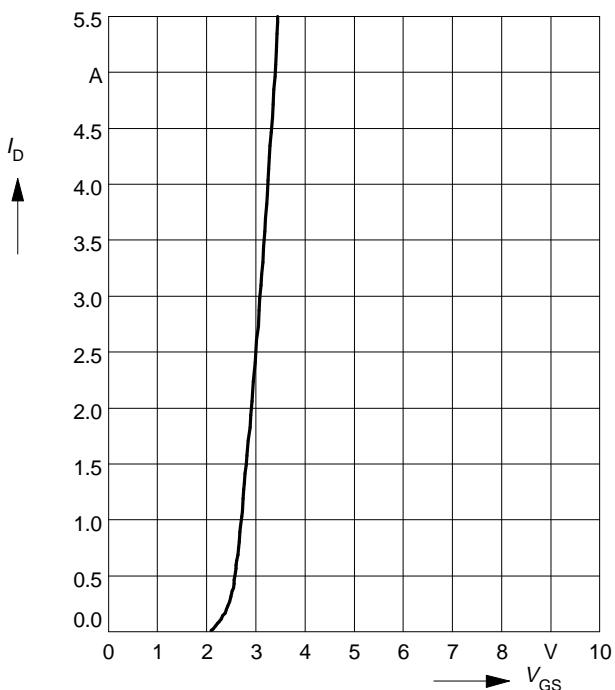


Typ. output characteristics

$I_D = f(V_{DS})$
parameter: $t_p = 80 \mu\text{s}$, $T_j = 25^\circ\text{C}$

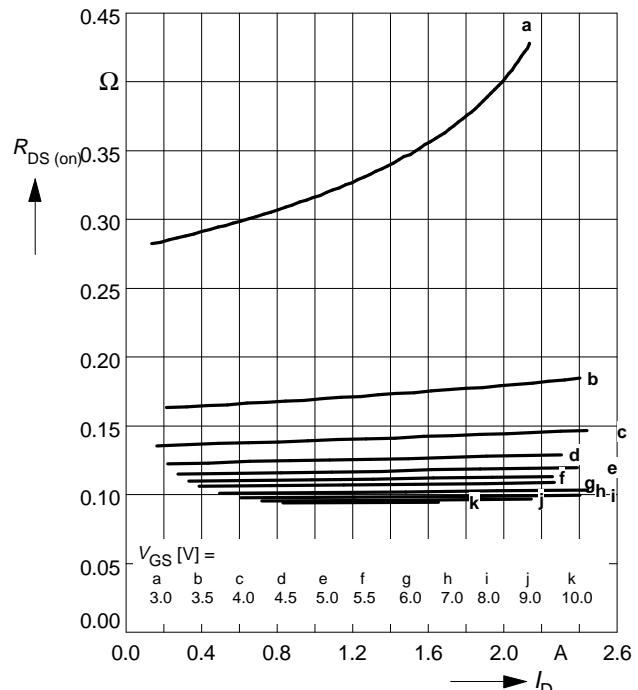


Typ. transfer characteristics $I_D = f(V_{GS})$
parameter: $t_p = 80 \mu\text{s}$

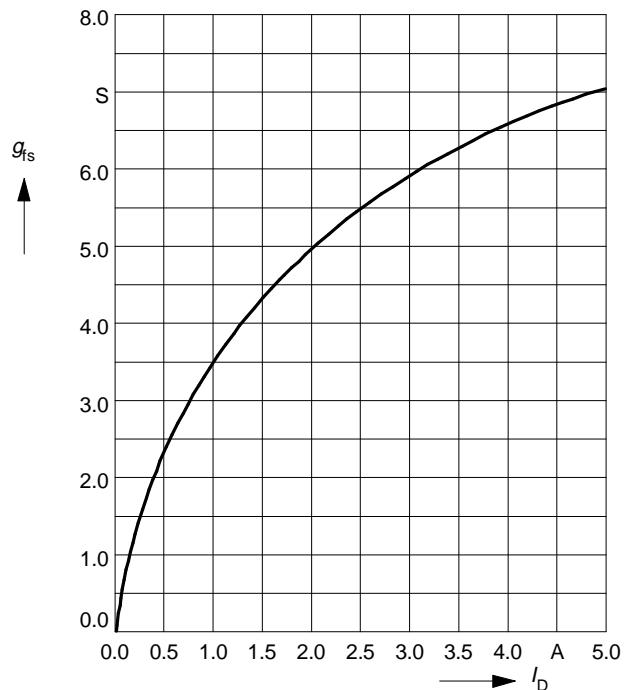


Typ. drain-source on-resistance

$R_{DS(on)} = f(I_D)$
parameter: $t_p = 80 \mu\text{s}$, $T_j = 25^\circ\text{C}$



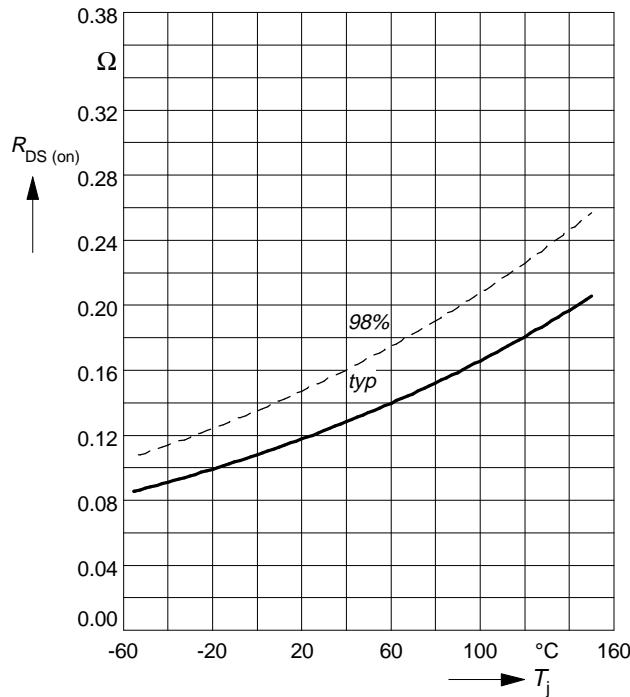
Typ. forward transconductance $g_{fs} = f(I_D)$
parameter: $t_p = 80 \mu\text{s}$,



Drain-source on-resistance

$$R_{DS(on)} = f(T_j)$$

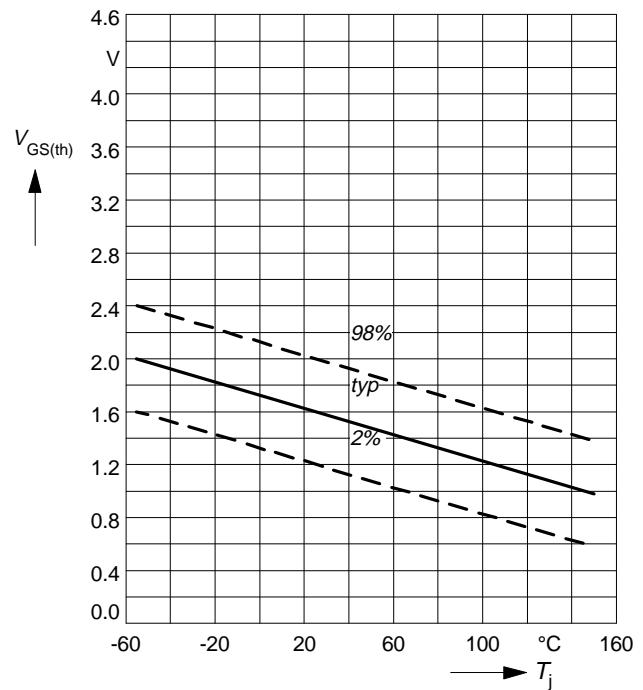
parameter: $I_D = 2.6 \text{ A}$, $V_{GS} = 5 \text{ V}$



Gate threshold voltage

$$V_{GS(th)} = f(T_j)$$

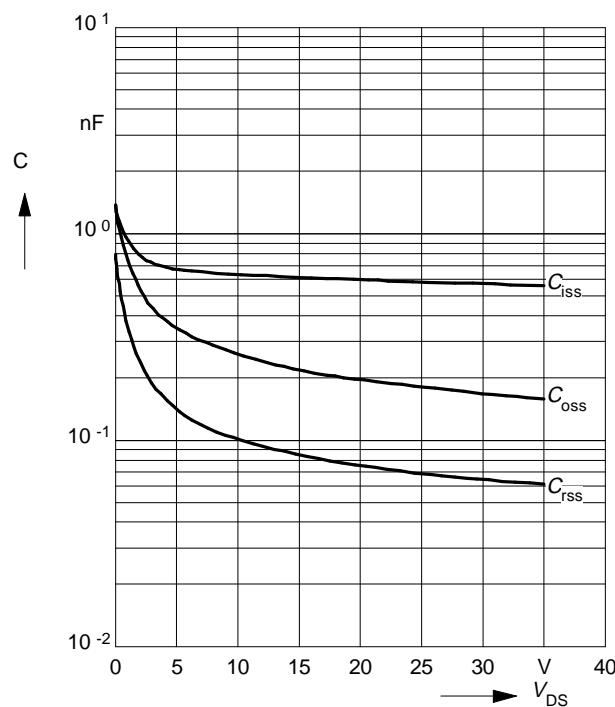
parameter: $V_{GS} = V_{DS}$, $I_D = 1 \text{ mA}$



Typ. capacitances

$$C = f(V_{DS})$$

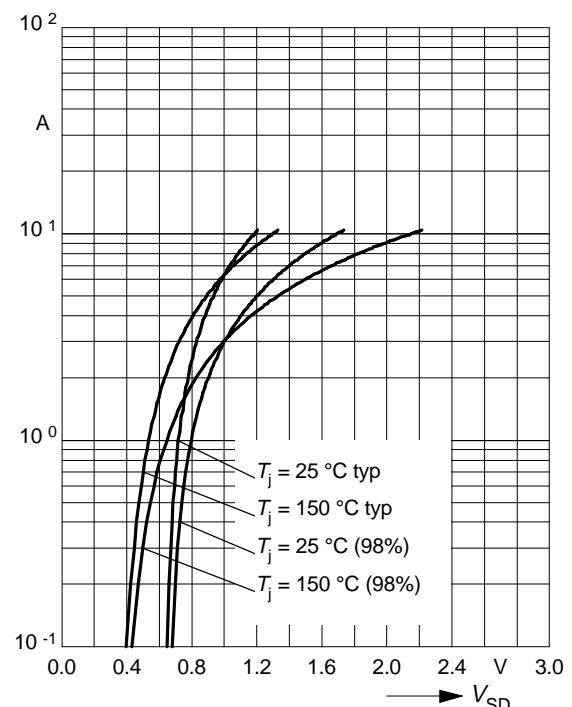
parameter: $V_{GS}=0\text{V}$, $f = 1 \text{ MHz}$



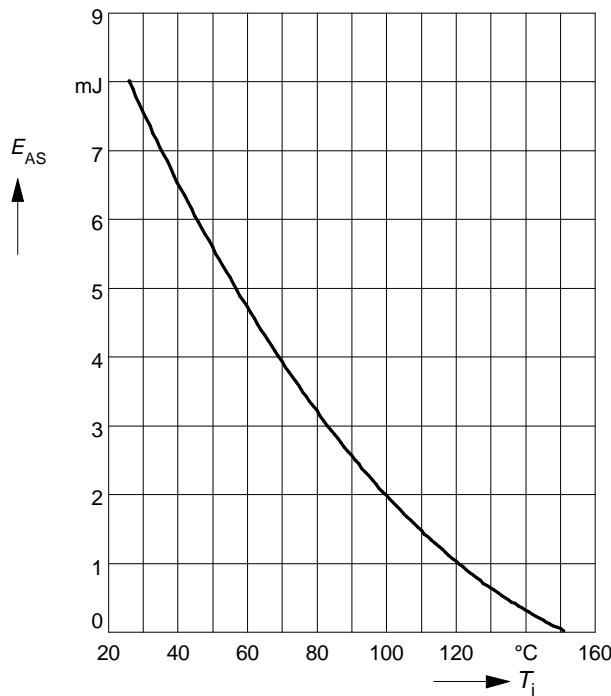
Forward characteristics of reverse diode

$$I_F = f(V_{SD})$$

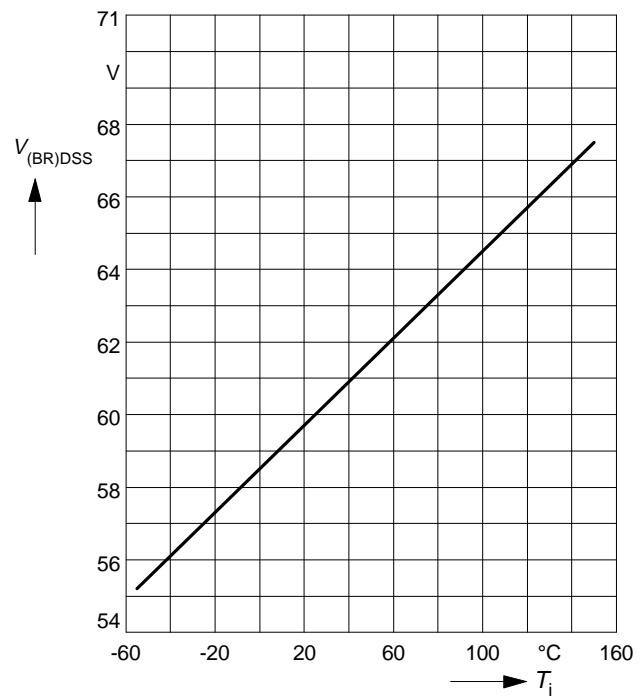
parameter: T_j , $t_p = 80 \mu\text{s}$



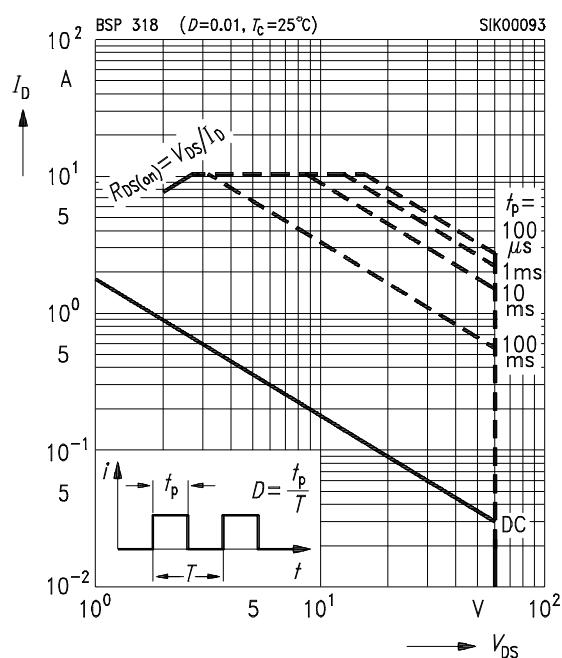
Avalanche energy $E_{AS} = f(T_j)$
 parameter: $I_D = 2.6 \text{ A}$, $V_{DD} = 25 \text{ V}$
 $R_{GS} = 25 \Omega$, $L = 1.38 \text{ mH}$



Drain-source breakdown voltage
 $V_{(BR)DSS} = f(T_j)$



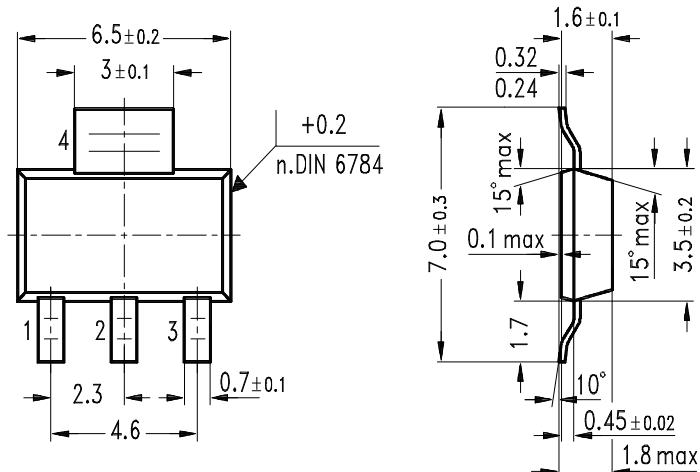
Safe operating area $I_D=f(V_{DS})$
 parameter : $D = 0.01$, $T_C=25^\circ\text{C}$



Package outlines

SOT-223

Dimensions in mm



GPS05560